



YOUSHANG SEMICONDUCTOR

设计研发新型功率器件

各类小信号开关

中低压及高压大电流等场效应管

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Description

This bipolar junction transistor (BJT) is designed to meet the stringent requirements of automotive applications.

Features

- $BV_{CEO} > -200V$
- $I_C = -2A$ High Continuous Collector Current
- $I_C = -5A$ Peak Pulse Current
- Low Saturation Voltage $V_{CE(sat)} < -165mV @ -1A$
- h_{FE} Specified up to -5A for a High Gain Hold-Up

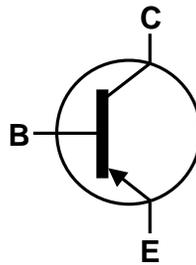
Mechanical Data

- Package: SOT223 (Type ZN)
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.112 grams (Approximate)

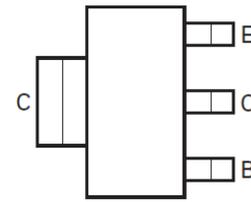
SOT223 (Type ZN)



Top View



Device Symbol



Top View
Pin-Out

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-220	V
Collector-Emitter Voltage	V _{CEO}	-200	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-2	A
Peak Pulse Current	I _{CM}	-5	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

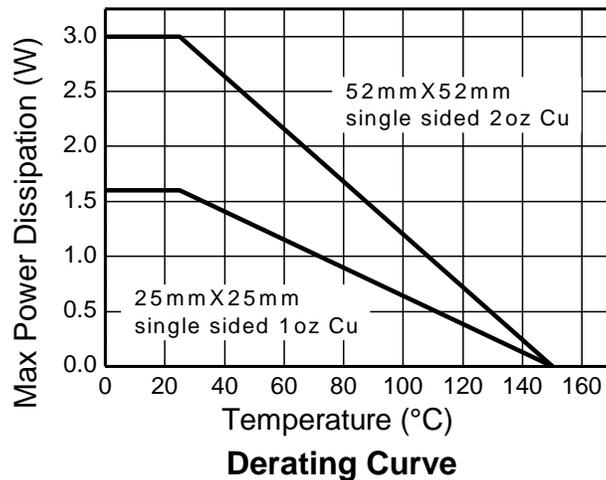
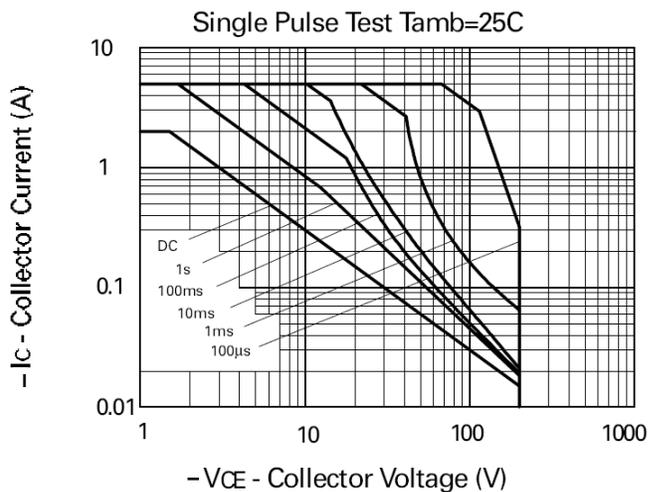
Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	3.0	W
		24	
Linear Derating Factor		1.6	mW /°C
		12.8	
Thermal Resistance, Junction to Ambient	R _{θJA} (Note 5)	42	°C/W
	R _{θJA} (Note 6)	78	
Thermal Resistance Junction to Lead	R _{θJL} (Note 7)	8.8	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 8)

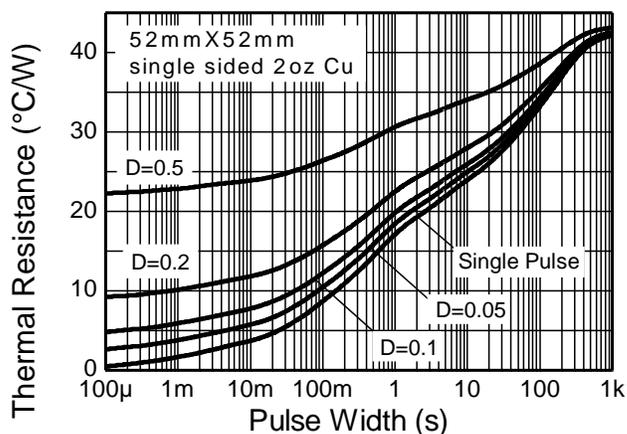
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the collector lead on 52mm x 52mm 2oz copper that is on a single sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady state.
 - Same as Note 5, except mounted on 25mm x 25mm 1oz copper.
 - Thermal resistance from junction to solder-point (at the end of the collector lead).
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

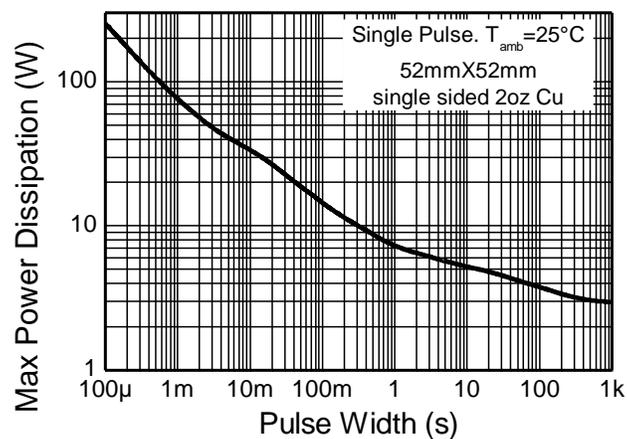
Thermal Characteristics and Derating Information



Safe Operating Area



Transient Thermal Impedance



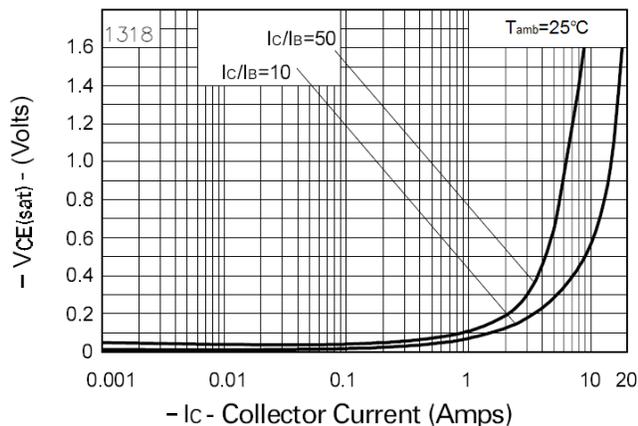
Pulse Power Dissipation

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

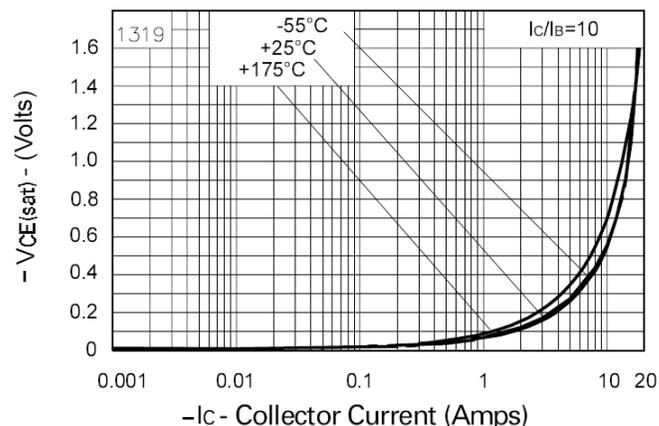
Characteristic	Symbol	Min	Typ.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	-220	-300	—	V	$I_C = -100\mu\text{A}$
Collector-Emitter Breakdown Voltage (Note 9)	BV_{CER}	-220	-300	—	V	$I_C = -1\mu\text{A}$, $R_B \leq 1\text{k}\Omega$
Collector-Emitter Breakdown Voltage (Note 9)	BV_{CEO}	-200	-240	—	V	$I_C = -1\text{mA}$
Emitter-Base Breakdown Voltage	BV_{EBO}	-7	-8.3	—	V	$I_E = -100\mu\text{A}$
Collector Cut-Off Current	I_{CBO}	—	—	-50 -1	nA μA	$V_{CB} = -200\text{V}$ $V_{CB} = -200\text{V}$, $T_A = +100^\circ\text{C}$
Collector Cut-Off Current	I_{CER}	—	—	-50 -1	nA μA	$V_{CE} = -200\text{V}$, $R \leq 1\text{k}\Omega$ $V_{CE} = -200\text{V}$, $T_A = +100^\circ\text{C}$
Emitter Cut-Off Current	I_{EBO}	—	—	-10	nA	$V_{EB} = -6\text{V}$
DC Current Transfer Static Ratio (Note 9)	h_{FE}	100	200	—	—	$I_C = -10\text{mA}$, $V_{CE} = -5\text{V}$
		100	200	300		$I_C = -1\text{A}$, $V_{CE} = -5\text{V}$
		50	150	—		$I_C = -2\text{A}$, $V_{CE} = -5\text{V}$
		—	10	—		$I_C = -5\text{A}$, $V_{CE} = -5\text{V}$
Collector-Emitter Saturation Voltage (Note 9)	$V_{CE(sat)}$	—	-30	-50	mV	$I_C = -100\text{mA}$, $I_B = -10\text{mA}$
		—	-120	-165		$I_C = -1\text{A}$, $I_B = -100\text{mA}$
		—	-168	-275		$I_C = -2\text{A}$, $I_B = -400\text{mA}$
Base-Emitter Saturation Voltage (Note 9)	$V_{BE(sat)}$	—	-970	-1,110	mV	$I_C = -2\text{A}$, $I_B = -400\text{mA}$
Base-Emitter Turn-On Voltage (Note 9)	$V_{BE(on)}$	—	-810	-950	mV	$I_C = -2\text{A}$, $V_{CE} = -5\text{V}$
Transitional Frequency (Note 9)	f_T	—	110	—	MHz	$I_C = -100\text{mA}$, $V_{CE} = -10\text{V}$, $f = 50\text{MHz}$
Output Capacitance	C_{obo}	—	32	—	pF	$V_{CB} = -20\text{V}$, $f = 1\text{MHz}$
Switching Time	t_{on}	—	67	—	ns	$V_{CC} = -50\text{V}$, $I_C = -1\text{A}$, $-I_{B1} = I_{B2} = -100\text{mA}$
	t_{off}	—	1,140	—		

 Note: 9. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

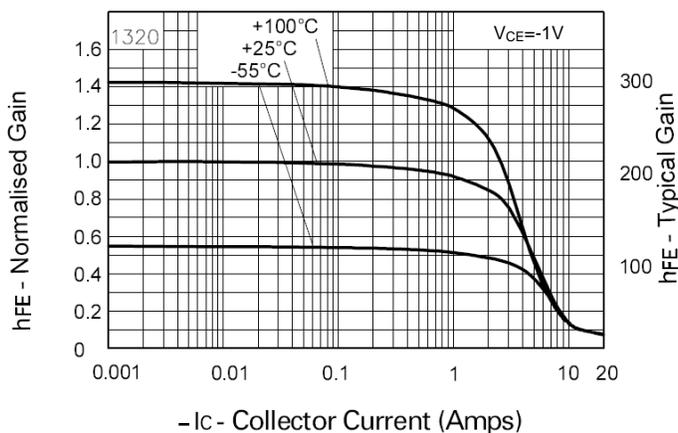
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



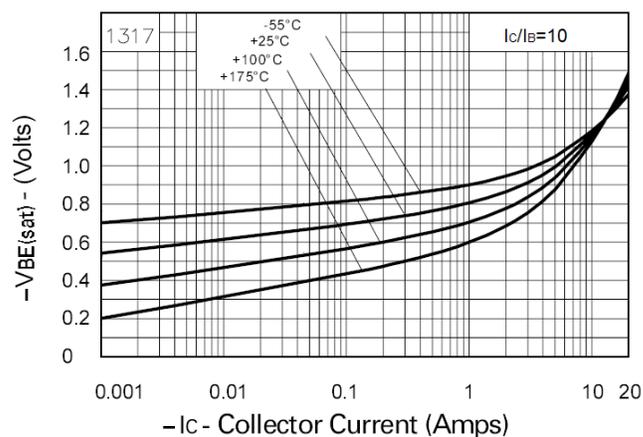
VCE(sat) v IC



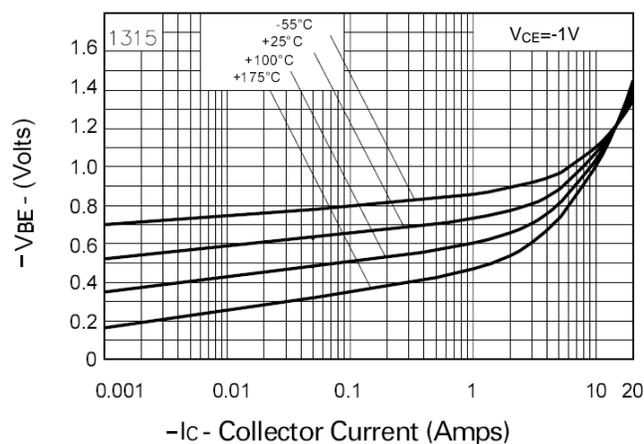
VCE(sat) v IC



hFE v IC



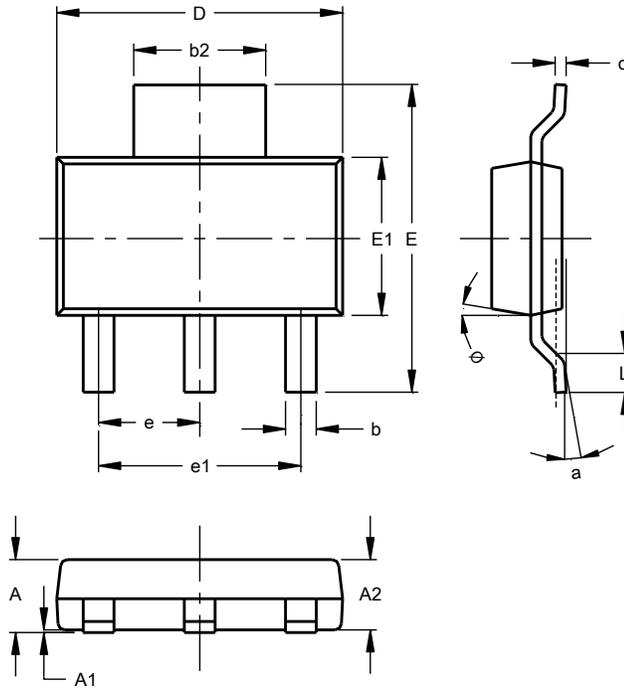
VBE(sat) v IC



VBE(on) v IC

Package Outline Dimensions

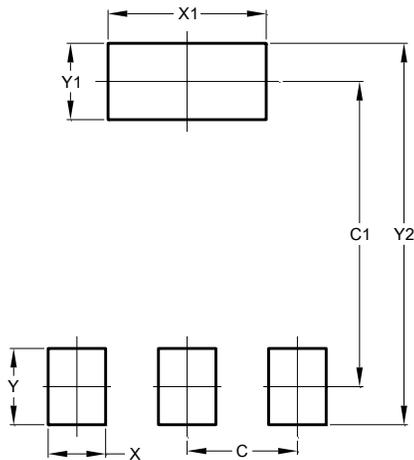
SOT223 (Type ZN)



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Dim	Min	Max	Typ
A	--	1.70	--
A1	0.02	0.10	--
A2	1.50	1.68	1.60
b	0.60	0.80	--
b2	2.90	3.10	--
c	0.24	0.32	--
D	6.30	6.70	--
E	6.70	7.30	--
E1	3.30	3.70	--
e	2.30 NOM		
e1	4.60 NOM		
L	0.90	--	--
a	--	--	10°
Θ	--	15°	--
All Dimensions in mm			

Suggested Pad Layout

SOT223 (Type ZN)



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00